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## Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

## Applications of Embedded - CPLDs

### Details

Product Status	Active
Programmable Type	In System Programmable
Delay Time tpd(1) Max	5 ns
Voltage Supply - Internal	1.7V ~ 1.9V
Number of Logic Elements/Blocks	4
Number of Macrocells	64
Number of Gates	-
Number of I/O	32
Operating Temperature	0°C ~ 90°C (TJ)
Mounting Type	Surface Mount
Package / Case	56-LFBGA, CSPBGA
Supplier Device Package	56-CSBGA (6x6)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4064zc-5mn56c">https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4064zc-5mn56c</a>

**Table 7. ORP Combinations for I/O Blocks with 16 I/Os**

I/O Cell	Available Macrocells
I/O 0	M0, M1, M2, M3, M4, M5, M6, M7
I/O 1	M1, M2, M3, M4, M5, M6, M7, M8
I/O 2	M2, M3, M4, M5, M6, M7, M8, M9
I/O 3	M3, M4, M5, M6, M7, M8, M9, M10
I/O 4	M4, M5, M6, M7, M8, M9, M10, M11
I/O 5	M5, M6, M7, M8, M9, M10, M11, M12
I/O 6	M6, M7, M8, M9, M10, M11, M12, M13
I/O 7	M7, M8, M9, M10, M11, M12, M13, M14
I/O 8	M8, M9, M10, M11, M12, M13, M14, M15
I/O 9	M9, M10, M11, M12, M13, M14, M15, M0
I/O 10	M10, M11, M12, M13, M14, M15, M0, M1
I/O 11	M11, M12, M13, M14, M15, M0, M1, M2
I/O 12	M12, M13, M14, M15, M0, M1, M2, M3
I/O 13	M13, M14, M15, M0, M1, M2, M3, M4
I/O 14	M14, M15, M0, M1, M2, M3, M4, M5
I/O 15	M15, M0, M1, M2, M3, M4, M5, M6

**Table 8. ORP Combinations for I/O Blocks with 4 I/Os**

I/O Cell	Available Macrocells
I/O 0	M0, M1, M2, M3, M4, M5, M6, M7
I/O 1	M4, M5, M6, M7, M8, M9, M10, M11
I/O 2	M8, M9, M10, M11, M12, M13, M14, M15
I/O 3	M12, M13, M14, M15, M0, M1, M2, M3

**Table 9. ORP Combinations for I/O Blocks with 10 I/Os**

I/O Cell	Available Macrocells
I/O 0	M0, M1, M2, M3, M4, M5, M6, M7
I/O 1	M2, M3, M4, M5, M6, M7, M8, M9
I/O 2	M4, M5, M6, M7, M8, M9, M10, M11
I/O 3	M6, M7, M8, M9, M10, M11, M12, M13
I/O 4	M8, M9, M10, M11, M12, M13, M14, M15
I/O 5	M10, M11, M12, M13, M14, M15, M0, M1
I/O 6	M12, M13, M14, M15, M0, M1, M2, M3
I/O 7	M14, M15, M0, M1, M2, M3, M4, M5
I/O 8	M2, M3, M4, M5, M6, M7, M8, M9
I/O 9	M10, M11, M12, M13, M14, M15, M0, M1

- LVTTTL
- LVC MOS 3.3
- LVC MOS 2.5
- LVC MOS 1.8
- 3.3V PCI Compatible

All of the I/Os and dedicated inputs have the capability to provide a bus-keeper latch, Pull-up Resistor or Pull-down Resistor. A fourth option is to provide none of these. The selection is done on a global basis. The default in both hardware and software is such that when the device is erased or if the user does not specify, the input structure is configured to be a Pull-up Resistor.

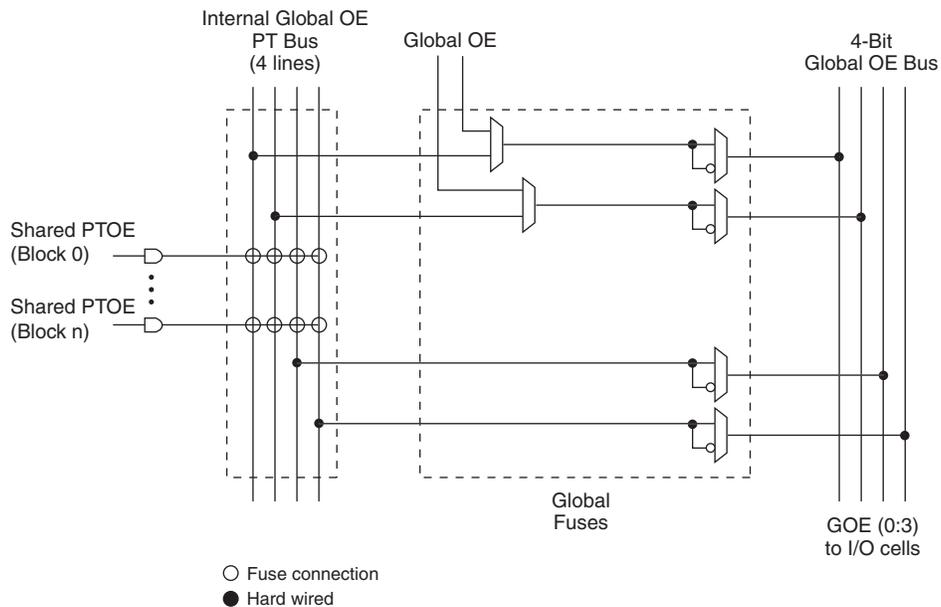
Each ispMACH 4000 device I/O has an individually programmable output slew rate control bit. Each output can be individually configured for fast slew or slow slew. The typical edge rate difference between fast and slow slew setting is 20%. For high-speed designs with long, unterminated traces, the slow-slew rate will introduce fewer reflections, less noise and keep ground bounce to a minimum. For designs with short traces or well terminated lines, the fast slew rate can be used to achieve the highest speed.

### Global OE Generation

Most ispMACH 4000 family devices have a 4-bit wide Global OE Bus, except the ispMACH 4032 device that has a 2-bit wide Global OE Bus. This bus is derived from a 4-bit internal global OE PT bus and two dual purpose I/O or GOE pins. Each signal that drives the bus can optionally be inverted.

Each GLB has a block-level OE PT that connects to all bits of the Global OE PT bus with four fuses. Hence, for a 256-macrocell device (with 16 blocks), each line of the bus is driven from 16 OE product terms. Figures 9 and 10 show a graphical representation of the global OE generation.

**Figure 9. Global OE Generation for All Devices Except ispMACH 4032**



## I/O DC Electrical Characteristics

### Over Recommended Operating Conditions

Standard	$V_{IL}$		$V_{IH}$		$V_{OL}$ Max (V)	$V_{OH}$ Min (V)	$I_{OL}^1$ (mA)	$I_{OH}^1$ (mA)
	Min (V)	Max (V)	Min (V)	Max (V)				
LVTTTL	-0.3	0.80	2.0	5.5	0.40	$V_{CCO} - 0.40$	8.0	-4.0
					0.20	$V_{CCO} - 0.20$	0.1	-0.1
LVCMOS 3.3	-0.3	0.80	2.0	5.5	0.40	$V_{CCO} - 0.40$	8.0	-4.0
					0.20	$V_{CCO} - 0.20$	0.1	-0.1
LVCMOS 2.5	-0.3	0.70	1.70	3.6	0.40	$V_{CCO} - 0.40$	8.0	-4.0
					0.20	$V_{CCO} - 0.20$	0.1	-0.1
LVCMOS 1.8 (4000V/B)	-0.3	0.63	1.17	3.6	0.40	$V_{CCO} - 0.45$	2.0	-2.0
					0.20	$V_{CCO} - 0.20$	0.1	-0.1
LVCMOS 1.8 (4000C/Z)	-0.3	$0.35 * V_{CC}$	$0.65 * V_{CC}$	3.6	0.40	$V_{CCO} - 0.45$	2.0	-2.0
					0.20	$V_{CCO} - 0.20$	0.1	-0.1
PCI 3.3 (4000V/B)	-0.3	1.08	1.5	5.5	$0.1 V_{CCO}$	$0.9 V_{CCO}$	1.5	-0.5
PCI 3.3 (4000C/Z)	-0.3	$0.3 * 3.3 * (V_{CC} / 1.8)$	$0.5 * 3.3 * (V_{CC} / 1.8)$	5.5	$0.1 V_{CCO}$	$0.9 V_{CCO}$	1.5	-0.5

1. The average DC current drawn by I/Os between adjacent bank GND connections, or between the last GND in an I/O bank and the end of the I/O bank, as shown in the logic signals connection table, shall not exceed  $n * 8mA$ . Where  $n$  is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank.

## ispMACH 4000V/B/C External Switching Characteristics

Over Recommended Operating Conditions

Parameter	Description <sup>1, 2, 3</sup>	-25		-27		-3		-35		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>PD</sub>	5-PT bypass combinatorial propagation delay	—	2.5	—	2.7	—	3.0	—	3.5	ns
t <sub>PD_MC</sub>	20-PT combinatorial propagation delay through macrocell	—	3.2	—	3.5	—	3.8	—	4.2	ns
t <sub>S</sub>	GLB register setup time before clock	1.8	—	1.8	—	2.0	—	2.0	—	ns
t <sub>ST</sub>	GLB register setup time before clock with T-type register	2.0	—	2.0	—	2.2	—	2.2	—	ns
t <sub>SIR</sub>	GLB register setup time before clock, input register path	0.7	—	1.0	—	1.0	—	1.0	—	ns
t <sub>SIRZ</sub>	GLB register setup time before clock with zero hold	1.7	—	2.0	—	2.0	—	2.0	—	ns
t <sub>H</sub>	GLB register hold time after clock	0.0	—	0.0	—	0.0	—	0.0	—	ns
t <sub>HT</sub>	GLB register hold time after clock with T-type register	0.0	—	0.0	—	0.0	—	0.0	—	ns
t <sub>HIR</sub>	GLB register hold time after clock, input register path	0.9	—	1.0	—	1.0	—	1.0	—	ns
t <sub>HIRZ</sub>	GLB register hold time after clock, input register path with zero hold	0.0	—	0.0	—	0.0	—	0.0	—	ns
t <sub>CO</sub>	GLB register clock-to-output delay	—	2.2	—	2.7	—	2.7	—	2.7	ns
t <sub>R</sub>	External reset pin to output delay	—	3.5	—	4.0	—	4.4	—	4.5	ns
t <sub>RW</sub>	External reset pulse duration	1.5	—	1.5	—	1.5	—	1.5	-	ns
t <sub>P<sub>TOE/DIS</sub></sub>	Input to output local product term output enable/disable	—	4.0	—	4.5	—	5.0	—	5.5	ns
t <sub>G<sub>P<sub>TOE/DIS</sub></sub></sub>	Input to output global product term output enable/disable	—	5.0	—	6.5	—	8.0	—	8.0	ns
t <sub>G<sub>OE/DIS</sub></sub>	Global OE input to output enable/disable	—	3.0	—	3.5	—	4.0	—	4.5	ns
t <sub>CW</sub>	Global clock width, high or low	1.1	—	1.3	—	1.3	—	1.3	—	ns
t <sub>GW</sub>	Global gate width low (for low transparent) or high (for high transparent)	1.1	—	1.3	—	1.3	—	1.3	—	ns
t <sub>WIR</sub>	Input register clock width, high or low	1.1	—	1.3	—	1.3	—	1.3	—	ns
f <sub>MAX</sub> <sup>4</sup>	Clock frequency with internal feedback	—	400	—	333	—	322	—	322	MHz
f <sub>MAX</sub> (Ext.)	Clock frequency with external feedback, [1/ (t <sub>S</sub> + t <sub>CO</sub> )]	—	250	—	222	—	212	—	212	MHz

1. Timing numbers are based on default LVCMOS 1.8 I/O buffers. Use timing adjusters provided to calculate other standards.

Timing v.3.2

2. Measured using standard switching circuit, assuming GRP loading of 1 and 1 output switching.

3. Pulse widths and clock widths less than minimum will cause unknown behavior.

4. Standard 16-bit counter using GRP feedback.

## ispMACH 4000V/B/C External Switching Characteristics (Cont.)

Over Recommended Operating Conditions

Parameter	Description <sup>1, 2, 3</sup>	-5		-75		-10		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>PD</sub>	5-PT bypass combinatorial propagation delay	—	5.0	—	7.5	—	10.0	ns
t <sub>PD_MC</sub>	20-PT combinatorial propagation delay through macrocell	—	5.5	—	8.0	—	10.5	ns
t <sub>S</sub>	GLB register setup time before clock	3.0	—	4.5	—	5.5	—	ns
t <sub>ST</sub>	GLB register setup time before clock with T-type register	3.2	—	4.7	—	5.5	—	ns
t <sub>SIR</sub>	GLB register setup time before clock, input register path	1.2	—	1.7	—	1.7	—	ns
t <sub>SIRZ</sub>	GLB register setup time before clock with zero hold	2.2	—	2.7	—	2.7	—	ns
t <sub>H</sub>	GLB register hold time after clock	0.0	—	0.0	—	0.0	—	ns
t <sub>HT</sub>	GLB register hold time after clock with T-type register	0.0	—	0.0	—	0.0	—	ns
t <sub>HIR</sub>	GLB register hold time after clock, input register path	1.0	—	1.0	—	1.0	—	ns
t <sub>HIRZ</sub>	GLB register hold time after clock, input register path with zero hold	0.0	—	0.0	—	0.0	—	ns
t <sub>CO</sub>	GLB register clock-to-output delay	—	3.4	—	4.5	—	6.0	ns
t <sub>R</sub>	External reset pin to output delay	—	6.3	—	9.0	—	10.5	ns
t <sub>RW</sub>	External reset pulse duration	2.0	—	4.0	—	4.0	—	ns
t <sub>P<sub>TOE/DIS</sub></sub>	Input to output local product term output enable/disable	—	7.0	—	9.0	—	10.5	ns
t <sub>G<sub>P<sub>TOE/DIS</sub></sub></sub>	Input to output global product term output enable/disable	—	9.0	—	10.3	—	12.0	ns
t <sub>GOE/DIS</sub>	Global OE input to output enable/disable	—	5.0	—	7.0	—	8.0	ns
t <sub>CW</sub>	Global clock width, high or low	2.2	—	2.8	—	4.0	—	ns
t <sub>GW</sub>	Global gate width low (for low transparent) or high (for high transparent)	2.2	—	2.8	—	4.0	—	ns
t <sub>WIR</sub>	Input register clock width, high or low	2.2	—	2.8	—	4.0	—	ns
f <sub>MAX</sub> <sup>4</sup>	Clock frequency with internal feedback	—	227	—	168	—	125	MHz
f <sub>MAX</sub> (Ext.)	Clock frequency with external feedback, [1/ (t <sub>S</sub> + t <sub>CO</sub> )]	—	156	—	111	—	86	MHz

1. Timing numbers are based on default LVCMOS 1.8 I/O buffers. Use timing adjusters provided to calculate other standards.

Timing v.3.2

2. Measured using standard switching circuit, assuming GRP loading of 1 and 1 output switching.

3. Pulse widths and clock widths less than minimum will cause unknown behavior.

4. Standard 16-bit counter using GRP feedback.

## ispMACH 4000Z External Switching Characteristics

Over Recommended Operating Conditions

Parameter	Description <sup>1, 2, 3</sup>	-35		-37		-42		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>PD</sub>	5-PT bypass combinatorial propagation delay	—	3.5	—	3.7	—	4.2	ns
t <sub>PD_MC</sub>	20-PT combinatorial propagation delay through macrocell	—	4.4	—	4.7	—	5.7	ns
t <sub>S</sub>	GLB register setup time before clock	2.2	—	2.5	—	2.7	—	ns
t <sub>ST</sub>	GLB register setup time before clock with T-type register	2.4	—	2.7	—	2.9	—	ns
t <sub>SIR</sub>	GLB register setup time before clock, input register path	1.0	—	1.1	—	1.3	—	ns
t <sub>SIRZ</sub>	GLB register setup time before clock with zero hold	2.0	—	2.1	—	2.6	—	ns
t <sub>H</sub>	GLB register hold time after clock	0.0	—	0.0	—	0.0	—	ns
t <sub>HT</sub>	GLB register hold time after clock with T-type register	0.0	—	0.0	—	0.0	—	ns
t <sub>HIR</sub>	GLB register hold time after clock, input register path	1.0	—	1.0	—	1.3	—	ns
t <sub>HIRZ</sub>	GLB register hold time after clock, input register path with zero hold	0.0	—	0.0	—	0.0	—	ns
t <sub>CO</sub>	GLB register clock-to-output delay	—	3.0	—	3.2	—	3.5	ns
t <sub>R</sub>	External reset pin to output delay	—	5.0	—	6.0	—	7.3	ns
t <sub>RW</sub>	External reset pulse duration	1.5	—	1.7	—	2.0	—	ns
t <sub>P<sub>TOE/DIS</sub></sub>	Input to output local product term output enable/disable	—	7.0	—	8.0	—	8.0	ns
t <sub>G<sub>P</sub>TOE/DIS</sub>	Input to output global product term output enable/disable	—	6.5	—	7.0	—	8.0	ns
t <sub>GOE/DIS</sub>	Global OE input to output enable/disable	—	4.5	—	4.5	—	4.8	ns
t <sub>CW</sub>	Global clock width, high or low	1.0	—	1.5	—	1.8	—	ns
t <sub>GW</sub>	Global gate width low (for low transparent) or high (for high transparent)	1.0	—	1.5	—	1.8	—	ns
t <sub>WIR</sub>	Input register clock width, high or low	1.0	—	1.5	—	1.8	—	ns
f <sub>MAX</sub> <sup>4</sup>	Clock frequency with internal feedback	—	267	—	250	—	220	MHz
f <sub>MAX</sub> (Ext.)	clock frequency with external feedback, [1 / (t <sub>S</sub> + t <sub>CO</sub> )]	—	192	—	175	—	161	MHz

1. Timing numbers are based on default LVCMOS 1.8 I/O buffers. Use timing adjusters provided to calculate other standards.

Timing v.2.2

2. Measured using standard switching GRP loading of 1 and 1 output switching.

3. Pulse widths and clock widths less than minimum will cause unknown behavior.

4. Standard 16-bit counter using GRP feedback.

ispMACH 4000V/B/C Timing Adders<sup>1</sup>

Adder Type	Base Parameter	Description	-25		-27		-3		-35		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>Optional Delay Adders</b>											
t <sub>INDIO</sub>	t <sub>INREG</sub>	Input register delay	—	0.95	—	1.00	—	1.00	—	1.00	ns
t <sub>EXP</sub>	t <sub>MCELL</sub>	Product term expander delay	—	0.33	—	0.33	—	0.33	—	0.33	ns
t <sub>ORP</sub>	—	Output routing pool delay	—	0.05	—	0.05	—	0.05	—	0.05	ns
t <sub>BLA</sub>	t <sub>ROUTE</sub>	Additional block loading adder	—	0.03	—	0.05	—	0.05	—	0.05	ns
<b>t<sub>IOI</sub> Input Adjusters</b>											
LVTTTL_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVTTTL standard	—	0.60	—	0.60	—	0.60	—	0.60	ns
LVC MOS33_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 3.3 standard	—	0.60	—	0.60	—	0.60	—	0.60	ns
LVC MOS25_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 2.5 standard	—	0.60	—	0.60	—	0.60	—	0.60	ns
LVC MOS18_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 1.8 standard	—	0.00	—	0.00	—	0.00	—	0.00	ns
PCI_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using PCI compatible input	—	0.60	—	0.60	—	0.60	—	0.60	ns
<b>t<sub>IOO</sub> Output Adjusters</b>											
LVTTTL_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as TTL buffer	—	0.20	—	0.20	—	0.20	—	0.20	ns
LVC MOS33_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 3.3V buffer	—	0.20	—	0.20	—	0.20	—	0.20	ns
LVC MOS25_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 2.5V buffer	—	0.10	—	0.10	—	0.10	—	0.10	ns
LVC MOS18_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 1.8V buffer	—	0.00	—	0.00	—	0.00	—	0.00	ns
PCI_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as PCI compatible buffer	—	0.20	—	0.20	—	0.20	—	0.20	ns
Slow Slew	t <sub>BUF</sub> , t <sub>EN</sub>	Output configured for slow slew rate	—	1.00	—	1.00	—	1.00	—	1.00	ns

Note: Open drain timing is the same as corresponding LVC MOS timing.

Timing v.3.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding use of these adders.

ispMACH 4000V/B/C Timing Adders<sup>1</sup> (Cont.)

Adder Type	Base Parameter	Description	-5		-75		-10		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
<b>Optional Delay Adders</b>									
$t_{INDIO}$	$t_{INREG}$	Input register delay	—	1.00	—	1.00	—	1.00	ns
$t_{EXP}$	$t_{MCELL}$	Product term expander delay	—	0.33	—	0.33	—	0.33	ns
$t_{ORP}$	—	Output routing pool delay	—	0.05	—	0.05	—	0.05	ns
$t_{BLA}$	$t_{ROUTE}$	Additional block loading adder	—	0.05	—	0.05	—	0.05	ns
<b><math>t_{IOI}</math> Input Adjusters</b>									
LVTTTL_in	$t_{IN}, t_{GCLK\_IN}, t_{GOE}$	Using LVTTTL standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS33_in	$t_{IN}, t_{GCLK\_IN}, t_{GOE}$	Using LVC MOS 3.3 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS25_in	$t_{IN}, t_{GCLK\_IN}, t_{GOE}$	Using LVC MOS 2.5 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS18_in	$t_{IN}, t_{GCLK\_IN}, t_{GOE}$	Using LVC MOS 1.8 standard	—	0.00	—	0.00	—	0.00	ns
PCI_in	$t_{IN}, t_{GCLK\_IN}, t_{GOE}$	Using PCI compatible input	—	0.60	—	0.60	—	0.60	ns
<b><math>t_{IOO}</math> Output Adjusters</b>									
LVTTTL_out	$t_{BUF}, t_{EN}, t_{DIS}$	Output configured as TTL buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS33_out	$t_{BUF}, t_{EN}, t_{DIS}$	Output configured as 3.3V buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS25_out	$t_{BUF}, t_{EN}, t_{DIS}$	Output configured as 2.5V buffer	—	0.10	—	0.10	—	0.10	ns
LVC MOS18_out	$t_{BUF}, t_{EN}, t_{DIS}$	Output configured as 1.8V buffer	—	0.00	—	0.00	—	0.00	ns
PCI_out	$t_{BUF}, t_{EN}, t_{DIS}$	Output configured as PCI compatible buffer	—	0.20	—	0.20	—	0.20	ns
Slow Slew	$t_{BUF}, t_{EN}$	Output configured for slow slew rate	—	1.00	—	1.00	—	1.00	ns

Note: Open drain timing is the same as corresponding LVC MOS timing.

Timing v.3.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding use of these adders.

ispMACH 4000Z Timing Adders <sup>1</sup>

Adder Type	Base Parameter	Description	-35		-37		-42		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
<b>Optional Delay Adders</b>									
t <sub>INDIO</sub>	t <sub>INREG</sub>	Input register delay	—	1.00	—	1.00	—	1.30	ns
t <sub>EXP</sub>	t <sub>MCELL</sub>	Product term expander delay	—	0.40	—	0.40	—	0.45	ns
t <sub>ORP</sub>	—	Output routing pool delay	—	0.40	—	0.40	—	0.40	ns
t <sub>BLA</sub>	t <sub>ROUTE</sub>	Additional block loading adder	—	0.04	—	0.05	—	0.05	ns
<b>t<sub>IOI</sub> Input Adjusters</b>									
LVTTTL_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVTTTL standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS33_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 3.3 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS25_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 2.5 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS18_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 1.8 standard	—	0.00	—	0.00	—	0.00	ns
PCI_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using PCI compatible input	—	0.60	—	0.60	—	0.60	ns
<b>t<sub>IOO</sub> Output Adjusters</b>									
LVTTTL_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as TTL buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS33_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 3.3V buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS25_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 2.5V buffer	—	0.10	—	0.10	—	0.10	ns
LVC MOS18_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 1.8V buffer	—	0.00	—	0.00	—	0.00	ns
PCI_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as PCI compatible buffer	—	0.20	—	0.20	—	0.20	ns
Slow Slew	t <sub>BUF</sub> , t <sub>EN</sub>	Output configured for slow slew rate	—	1.00	—	1.00	—	1.00	ns

Note: Open drain timing is the same as corresponding LVC MOS timing.

Timing v.2.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding the use of these adders.

**ispMACH 4032Z and 4064Z Logic Signal Connections: 56-Ball csBGA (Cont.)**

Ball Number	Bank Number	ispMACH 4032Z		ispMACH 4064Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
K5	0	A15	A <sup>15</sup>	B0	B <sup>0</sup>
H6	0	CLK1/I	-	CLK1/I	-
K6	1	CLK2/I	-	CLK2/I	-
H7	1	B0	B <sup>0</sup>	C0	C <sup>0</sup>
K7	1	B1	B <sup>1</sup>	C1	C <sup>1</sup>
K8	1	B2	B <sup>2</sup>	C2	C <sup>2</sup>
K9	1	B3	B <sup>3</sup>	C4	C <sup>3</sup>
K10	1	B4	B <sup>4</sup>	C6	C <sup>4</sup>
J10	-	TMS	-	TMS	-
H8	1	B5	B <sup>5</sup>	C8	C <sup>5</sup>
H10	1	B6	B <sup>6</sup>	C10	C <sup>6</sup>
G10	1	B7	B <sup>7</sup>	C11	C <sup>7</sup>
G8	1	GND (Bank 1)	-	GND (Bank 1)	-
F8	1	NC <sup>1</sup>	-	I <sup>1</sup>	-
F10	1	NC <sup>1</sup>	-	I <sup>1</sup>	-
E8	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-
E10	1	B8	B <sup>8</sup>	D15	D <sup>7</sup>
D8	1	B9	B <sup>9</sup>	D12	D <sup>6</sup>
D10	1	B10	B <sup>10</sup>	D10	D <sup>5</sup>
C10	1	B11	B <sup>11</sup>	D8	D <sup>4</sup>
B10	1	NC <sup>1</sup>	-	I <sup>1</sup>	-
A10	-	TDO	-	TDO	-
A9	-	VCC	-	VCC	-
C8	-	GND	-	GND	-
A8	1	NC <sup>1</sup>	-	I <sup>1</sup>	-
A7	1	B12	B <sup>12</sup>	D6	D <sup>3</sup>
C7	1	B13	B <sup>13</sup>	D4	D <sup>2</sup>
C6	1	B14	B <sup>14</sup>	D2	D <sup>1</sup>
A6	1	B15/GOE1	B <sup>15</sup>	D0/GOE1	D <sup>0</sup>
C5	1	CLK3/I	-	CLK3/I	-
A5	0	CLK0/I	-	CLK0/I	-
C4	0	A0/GOE0	A <sup>0</sup>	A0/GOE0	A <sup>0</sup>
A4	0	A1	A <sup>1</sup>	A1	A <sup>1</sup>
A3	0	A2	A <sup>2</sup>	A2	A <sup>2</sup>
A2	0	A3	A <sup>3</sup>	A4	A <sup>3</sup>
A1	0	A4	A <sup>4</sup>	A6	A <sup>4</sup>

1. For device migration considerations, these NC pins are input signal pins in ispMACH 4064Z devices.

**ispMACH 4128V/B/C Logic Signal Connections: 128-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4128V/B/C	
		GLB/MC/Pad	ORP
62	1	E10	E^8
63	1	E12	E^9
64	1	E14	E^11
65	1	GND	-
66	1	TMS	-
67	1	VCCO (Bank 1)	-
68	1	F0	F^0
69	1	F1	F^1
70	1	F2	F^2
71	1	F4	F^3
72	1	F5	F^4
73	1	F6	F^5
74	1	GND (Bank 1)	-
75	1	F8	F^6
76	1	F9	F^7
77	1	F10	F^8
78	1	F12	F^9
79	1	F13	F^10
80	1	F14	F^11
81	1	VCCO (Bank 1)	-
82	1	G14	G^11
83	1	G13	G^10
84	1	G12	G^9
85	1	G10	G^8
86	1	G9	G^7
87	1	G8	G^6
88	1	GND (Bank 1)	-
89	1	G6	G^5
90	1	G5	G^4
91	1	G4	G^3
92	1	G2	G^2
93	1	G0	G^0
94	1	VCCO (Bank 1)	-
95	1	TDO	-
96	1	VCC	-
97	1	GND	-
98	1	H14	H^11
99	1	H13	H^10
100	1	H12	H^9
101	1	H10	H^8
102	1	H9	H^7
103	1	H8	H^6
104	1	GND (Bank 1)	-

**ispMACH 4128V and 4256V Logic Signal Connections: 144-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4128V		ispMACH 4256V	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
43	0	D9	D <sup>^</sup> 7	G4	G <sup>^</sup> 2
44	0	D8	D <sup>^</sup> 6	G2	G <sup>^</sup> 1
45	0	NC <sup>2</sup>	-	I <sup>2</sup>	-
46	0	GND (Bank 0)	-	GND (Bank 0)	-
47	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-
48	0	D6	D <sup>^</sup> 5	H12	H <sup>^</sup> 6
49	0	D5	D <sup>^</sup> 4	H10	H <sup>^</sup> 5
50	0	D4	D <sup>^</sup> 3	H8	H <sup>^</sup> 4
51	0	D2	D <sup>^</sup> 2	H6	H <sup>^</sup> 3
52	0	D1	D <sup>^</sup> 1	H4	H <sup>^</sup> 2
53	0	D0	D <sup>^</sup> 0	H2	H <sup>^</sup> 1
54	0	CLK1/I	-	CLK1/I	-
55	1	GND (Bank 1)	-	GND (Bank 1)	-
56	1	CLK2/I	-	CLK2/I	-
57	-	VCC	-	VCC	-
58	1	E0	E <sup>^</sup> 0	I2	I <sup>^</sup> 1
59	1	E1	E <sup>^</sup> 1	I4	I <sup>^</sup> 2
60	1	E2	E <sup>^</sup> 2	I6	I <sup>^</sup> 3
61	1	E4	E <sup>^</sup> 3	I8	I <sup>^</sup> 4
62	1	E5	E <sup>^</sup> 4	I10	I <sup>^</sup> 5
63	1	E6	E <sup>^</sup> 5	I12	I <sup>^</sup> 6
64	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-
65	1	GND (Bank 1)	-	GND (Bank 1)	-
66	1	E8	E <sup>^</sup> 6	J2	J <sup>^</sup> 1
67	1	E9	E <sup>^</sup> 7	J4	J <sup>^</sup> 2
68	1	E10	E <sup>^</sup> 8	J6	J <sup>^</sup> 3
69	1	E12	E <sup>^</sup> 9	J8	J <sup>^</sup> 4
70	1	E13	E <sup>^</sup> 10	J10	J <sup>^</sup> 5
71	1	E14	E <sup>^</sup> 11	J12	J <sup>^</sup> 6
72	1	NC <sup>2</sup>	-	I <sup>2</sup>	-
73	-	GND	-	GND	-
74	-	TMS	-	TMS	-
75	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-
76	1	F0	F <sup>^</sup> 0	K12	K <sup>^</sup> 6
77	1	F1	F <sup>^</sup> 1	K10	K <sup>^</sup> 5
78	1	F2	F <sup>^</sup> 2	K8	K <sup>^</sup> 4
79	1	F4	F <sup>^</sup> 3	K6	K <sup>^</sup> 3
80	1	F5	F <sup>^</sup> 4	K4	K <sup>^</sup> 2
81	1	F6	F <sup>^</sup> 5	K2	K <sup>^</sup> 1
82	1	GND (Bank 1)	-	GND (Bank 1)	-
83	1	F8	F <sup>^</sup> 6	L14	L <sup>^</sup> 7
84	1	F9	F <sup>^</sup> 7	L12	L <sup>^</sup> 6
85	1	F10	F <sup>^</sup> 8	L10	L <sup>^</sup> 5

**ispMACH 4128V and 4256V Logic Signal Connections: 144-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4128V		ispMACH 4256V	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
129	-	VCC	-	VCC	-
130	0	A0/GOE0	A^0	A2/GOE0	A^1
131	0	A1	A^1	A4	A^2
132	0	A2	A^2	A6	A^3
133	0	A4	A^3	A8	A^4
134	0	A5	A^4	A10	A^5
135	0	A6	A^5	A12	A^6
136	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-
137	0	GND (Bank 0)	-	GND (Bank 0)	-
138	0	A8	A^6	B2	B^1
139	0	A9	A^7	B4	B^2
140	0	A10	A^8	B6	B^3
141	0	A12	A^9	B8	B^4
142	0	A13	A^10	B10	B^5
143	0	A14	A^11	B12	B^6
144	0	NC <sup>2</sup>	-	I <sup>2</sup>	-

1. For device migration considerations, these NC pins are GND pins for I/O banks in ispMACH 4128V devices.
2. For device migration considerations, these NC pins are input signal pins in ispMACH 4256V devices.

**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections: 176-Pin TQFP**

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
1	-	NC	-	NC	-	NC	-
2	-	GND	-	GND	-	GND	-
3	-	TDI	-	TDI	-	TDI	-
4	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
5	0	C14	C^7	C14	C^7	C14	C^7
6	0	C12	C^6	C12	C^6	C12	C^6
7	0	C10	C^5	C10	C^5	C10	C^5
8	0	C8	C^4	C8	C^4	C8	C^4
9	0	C6	C^3	C6	C^3	C6	C^3
10	0	C4	C^2	C4	C^2	C4	C^2
11	0	C2	C^1	C2	C^1	C2	C^1
12	0	C0	C^0	C0	C^0	C0	C^0
13	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
14	0	D14	D^7	E14	E^7	G14	G^7
15	0	D12	D^6	E12	E^6	G12	G^6
16	0	D10	D^5	E10	E^5	G10	G^5
17	0	D8	D^4	E8	E^4	G8	G^4
18	0	D6	D^3	E6	E^3	G6	G^3

**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections:  
176-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
101	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
102	1	L14	L^7	AX14	AX^7	GX14	GX^7
103	1	L12	L^6	AX12	AX^6	GX12	GX^6
104	1	L10	L^5	AX10	AX^5	GX10	GX^5
105	1	L8	L^4	AX8	AX^4	GX8	GX^4
106	1	L6	L^3	AX6	AX^3	GX6	GX^3
107	1	L4	L^2	AX4	AX^2	GX4	GX^2
108	1	L2	L^1	AX2	AX^1	GX2	GX^1
109	1	L0	L^0	AX0	AX^0	GX0	GX^0
110	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
111	1	M0	M^0	DX0	DX^0	JX0	JX^0
112	1	M2	M^1	DX2	DX^1	JX2	JX^1
113	1	M4	M^2	DX4	DX^2	JX4	JX^2
114	1	M6	M^3	DX6	DX^3	JX6	JX^3
115	1	M8	M^4	DX8	DX^4	JX8	JX^4
116	1	M10	M^5	DX10	DX^5	JX10	JX^5
117	1	M12	M^6	DX12	DX^6	JX12	JX^6
118	1	M14	M^7	DX14	DX^7	JX14	JX^7
119	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
120	1	N0	N^0	FX0	FX^0	NX0	NX^0
121	1	N2	N^1	FX2	FX^1	NX2	NX^1
122	1	N4	N^2	FX4	FX^2	NX4	NX^2
123	1	N6	N^3	FX6	FX^3	NX6	NX^3
124	1	N8	N^4	FX8	FX^4	NX8	NX^4
125	1	N10	N^5	FX10	FX^5	NX10	NX^5
126	1	N12	N^6	FX12	FX^6	NX12	NX^6
127	1	N14	N^7	FX14	FX^7	NX14	NX^7
128	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
129	-	TDO	-	TDO	-	TDO	-
130	-	VCC	-	VCC	-	VCC	-
131	-	NC	-	NC	-	NC	-
132	-	NC	-	NC	-	NC	-
133	-	NC	-	NC	-	NC	-
134	-	GND	-	GND	-	GND	-
135	1	O14	O^7	GX14	GX^7	OX14	OX^7
136	1	O12	O^6	GX12	GX^6	OX12	OX^6
137	1	O10	O^5	GX10	GX^5	OX10	OX^5
138	1	O8	O^4	GX8	GX^4	OX8	OX^4
139	1	O6	O^3	GX6	GX^3	OX6	OX^3
140	1	O4	O^2	GX4	GX^2	OX4	OX^2
141	1	O2	O^1	GX2	GX^1	OX2	OX^1

**ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections:  
256-Ball ftBGA/fpBGA (Cont.)**

Ball Number	I/O Bank	ispMACH 4256V/B/C 128-I/O		ispMACH 4256V/B/C 160-I/O		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
J6	0	E14	E <sup>7</sup>	E10	E <sup>7</sup>	H14	H <sup>7</sup>	J14	J <sup>7</sup>
K3	0	NC	-	E12	E <sup>8</sup>	G0	G <sup>0</sup>	I0	I <sup>0</sup>
K4	0	NC	-	E14	E <sup>9</sup>	G2	G <sup>1</sup>	I4	I <sup>1</sup>
L1	0	NC	-	NC	-	I14	I <sup>7</sup>	K0	K <sup>0</sup>
L2	0	NC	-	NC	-	I12	I <sup>6</sup>	K2	K <sup>1</sup>
M1	0	NC	-	NC	-	NC	-	K4	K <sup>2</sup>
-	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
-	0	-	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
M2	0	NC	-	NC	-	NC	-	K6	K <sup>3</sup>
N1	0	NC	-	NC	-	I10	I <sup>5</sup>	K8	K <sup>4</sup>
M3	0	NC	-	NC	-	I8	I <sup>4</sup>	K10	K <sup>5</sup>
M4	0	NC	-	F0	F <sup>0</sup>	G4	G <sup>2</sup>	I8	I <sup>2</sup>
N2	0	NC	-	F1	F <sup>1</sup>	G6	G <sup>3</sup>	I12	I <sup>3</sup>
K5	0	F0	F <sup>0</sup>	F2	F <sup>2</sup>	J0	J <sup>0</sup>	N0	N <sup>0</sup>
P1	0	F2	F <sup>1</sup>	F4	F <sup>3</sup>	J2	J <sup>1</sup>	N2	N <sup>1</sup>
K6	0	F4	F <sup>2</sup>	F6	F <sup>4</sup>	J4	J <sup>2</sup>	N4	N <sup>2</sup>
N3	0	F6	F <sup>3</sup>	F8	F <sup>5</sup>	J6	J <sup>3</sup>	N6	N <sup>3</sup>
L5	0	F8	F <sup>4</sup>	F9	F <sup>6</sup>	J8	J <sup>4</sup>	N8	N <sup>4</sup>
P2	0	F10	F <sup>5</sup>	F10	F <sup>7</sup>	J10	J <sup>5</sup>	N10	N <sup>5</sup>
L6	0	F12	F <sup>6</sup>	F12	F <sup>8</sup>	J12	J <sup>6</sup>	N12	N <sup>6</sup>
R1	0	F14	F <sup>7</sup>	F14	F <sup>9</sup>	J14	J <sup>7</sup>	N14	N <sup>7</sup>
-	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
P3	-	TCK	-	TCK	-	TCK	-	TCK	-
-	-	VCC	-	VCC	-	VCC	-	VCC	-
-	-	GND	-	GND	-	GND	-	GND	-
-	0	-	-	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
T2	0	NC	-	G14	G <sup>9</sup>	I6	I <sup>3</sup>	K12	K <sup>6</sup>
M5	0	NC	-	G12	G <sup>8</sup>	I4	I <sup>2</sup>	K14	K <sup>7</sup>
N4	0	G14	G <sup>7</sup>	G10	G <sup>7</sup>	K14	K <sup>7</sup>	O14	O <sup>7</sup>
T3	0	G12	G <sup>6</sup>	G9	G <sup>6</sup>	K12	K <sup>6</sup>	O12	O <sup>6</sup>
R3	0	G10	G <sup>5</sup>	G8	G <sup>5</sup>	K10	K <sup>5</sup>	O10	O <sup>5</sup>
M6	0	G8	G <sup>4</sup>	G6	G <sup>4</sup>	K8	K <sup>4</sup>	O8	O <sup>4</sup>
P4	0	G6	G <sup>3</sup>	G4	G <sup>3</sup>	K6	K <sup>3</sup>	O6	O <sup>3</sup>
L7	0	G4	G <sup>2</sup>	G2	G <sup>2</sup>	K4	K <sup>2</sup>	O4	O <sup>2</sup>
N5	0	G2	G <sup>1</sup>	G1	G <sup>1</sup>	K2	K <sup>1</sup>	O2	O <sup>1</sup>
M7	0	G0	G <sup>0</sup>	G0	G <sup>0</sup>	K0	K <sup>0</sup>	O0	O <sup>0</sup>
P5	0	NC	-	NC	-	G8	G <sup>4</sup>	M0	M <sup>0</sup>
R4	0	NC	-	NC	-	G10	G <sup>5</sup>	M4	M <sup>1</sup>
T4	0	NC	-	NC	-	NC	-	L0	L <sup>0</sup>
-	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
-	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-

**ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections:  
256-Ball ftBGA/fpBGA (Cont.)**

Ball Number	I/O Bank	ispMACH 4256V/B/C 128-I/O		ispMACH 4256V/B/C 160-I/O		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
H15	1	M2	M^1	M1	M^1	DX2	DX^1	JX2	JX^1
H14	1	M4	M^2	M2	M^2	DX4	DX^2	JX4	JX^2
H13	1	M6	M^3	M4	M^3	DX6	DX^3	JX6	JX^3
G16	1	M8	M^4	M6	M^4	DX8	DX^4	JX8	JX^4
H12	1	M10	M^5	M8	M^5	DX10	DX^5	JX10	JX^5
G15	1	M12	M^6	M9	M^6	DX12	DX^6	JX12	JX^6
H11	1	M14	M^7	M10	M^7	DX14	DX^7	JX14	JX^7
F16	1	NC	-	M12	M^8	CX0	CX^0	IX0	IX^0
G13	1	NC	-	M14	M^9	CX2	CX^1	IX4	IX^1
G14	1	NC	-	NC	-	EX14	EX^7	KX0	KX^0
F15	1	NC	-	NC	-	EX12	EX^6	KX2	KX^1
E16	1	NC	-	NC	-	NC	-	KX4	KX^2
-	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
-	1	-	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
E15	1	NC	-	NC	-	NC	-	KX6	KX^3
G12	1	NC	-	NC	-	EX10	EX^5	KX8	KX^4
E13	1	NC	-	NC	-	EX8	EX^4	KX10	KX^5
D16	1	NC	-	N0	N^0	CX4	CX^2	IX8	IX^2
E14	1	NC	-	N1	N^1	CX6	CX^3	IX12	IX^3
G11	1	N0	N^0	N2	N^2	FX0	FX^0	NX0	NX^0
D15	1	N2	N^1	N4	N^3	FX2	FX^1	NX2	NX^1
F11	1	N4	N^2	N6	N^4	FX4	FX^2	NX4	NX^2
C16	1	N6	N^3	N8	N^5	FX6	FX^3	NX6	NX^3
F12	1	N8	N^4	N9	N^6	FX8	FX^4	NX8	NX^4
D14	1	N10	N^5	N10	N^7	FX10	FX^5	NX10	NX^5
C15	1	N12	N^6	N12	N^8	FX12	FX^6	NX12	NX^6
B16	1	N14	N^7	N14	N^9	FX14	FX^7	NX14	NX^7
-	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
C14	-	TDO	-	TDO	-	TDO	-	TDO	-
-	-	VCC	-	VCC	-	VCC	-	VCC	-
-	-	GND	-	GND	-	GND	-	GND	-
-	1	-	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
A15	1	NC	-	NC	-	EX6	EX^3	KX12	KX^6
B14	1	NC	-	NC	-	EX4	EX^2	KX14	KX^7
E12	1	O14	O^7	O14	O^9	GX14	GX^7	OX14	OX^7
A14	1	O12	O^6	O12	O^8	GX12	GX^6	OX12	OX^6
C13	1	O10	O^5	O10	O^7	GX10	GX^5	OX10	OX^5
D13	1	O8	O^4	O9	O^6	GX8	GX^4	OX8	OX^4
E11	1	O6	O^3	O8	O^5	GX6	GX^3	OX6	OX^3
B13	1	O4	O^2	O6	O^4	GX4	GX^2	OX4	OX^2
F10	1	O2	O^1	O4	O^3	GX2	GX^1	OX2	OX^1

**ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections:  
256-Ball ftBGA/fpBGA (Cont.)**

Ball Number	I/O Bank	ispMACH 4256V/B/C 128-I/O		ispMACH 4256V/B/C 160-I/O		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
E7	0	NC	-	B1	B^1	F8	F^4	D12	D^3
A3	0	B0	B^0	B2	B^2	B0	B^0	B0	B^0
F7	0	B2	B^1	B4	B^3	B2	B^1	B2	B^1
B4	0	B4	B^2	B6	B^4	B4	B^2	B4	B^2
C5	0	B6	B^3	B8	B^5	B6	B^3	B6	B^3
A2	0	B8	B^4	B9	B^6	B8	B^4	B8	B^4
E6	0	B10	B^5	B10	B^7	B10	B^5	B10	B^5
B3	0	B12	B^6	B12	B^8	B12	B^6	B12	B^6
C4	0	B14	B^7	B14	B^9	B14	B^7	B14	B^7
D4	0	NC	-	NC	-	D10	D^5	F0	F^0
E5	0	NC	-	NC	-	D8	D^4	F2	F^1
-	-	VCC	-	VCC	-	VCC	-	VCC	-
-	-	-	-	-	-	GND	-	GND	-
-	0	-	-	-	-	GND (Bank 0)	-	GND (Bank 0)	-

Note: VCC, VCCO and GND are tied together to their respective common signal on the package substrate. See Power Supply and NC Connections table for VCC/ VCCO/GND pin definitions.

## ispMACH 4000C (1.8V) Industrial Devices (Cont.)

Family	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4384C	LC4384C-5FT256I	384	1.8	5	ftBGA	256	192	I
	LC4384C-75FT256I	384	1.8	7.5	ftBGA	256	192	I
	LC4384C-10FT256I	384	1.8	10	ftBGA	256	192	I
	LC4384C-5F256I <sup>1</sup>	384	1.8	5	fpBGA	256	192	I
	LC4384C-75F256I <sup>1</sup>	384	1.8	7.5	fpBGA	256	192	I
	LC4384C-10F256I <sup>1</sup>	384	1.8	10	fpBGA	256	192	I
	LC4384C-5T176I	384	1.8	5	TQFP	176	128	I
	LC4384C-75T176I	384	1.8	7.5	TQFP	176	128	I
	LC4384C-10T176I	384	1.8	10	TQFP	176	128	I
LC4512C	LC4512C-5FT256I	512	1.8	5	ftBGA	256	208	I
	LC4512C-75FT256I	512	1.8	7.5	ftBGA	256	208	I
	LC4512C-10FT256I	512	1.8	10	ftBGA	256	208	I
	LC4512C-5F256I <sup>1</sup>	512	1.8	5	fpBGA	256	208	I
	LC4512C-75F256I <sup>1</sup>	512	1.8	7.5	fpBGA	256	208	I
	LC4512C-10F256I <sup>1</sup>	512	1.8	10	fpBGA	256	208	I
	LC4512C-5T176I	512	1.8	5	TQFP	176	128	I
	LC4512C-75T176I	512	1.8	7.5	TQFP	176	128	I
	LC4512C-10T176I	512	1.8	10	TQFP	176	128	I

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

## ispMACH 4000B (2.5V) Commercial Devices

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032B	LC4032B-25T48C	32	2.5	2.5	TQFP	48	32	C
	LC4032B-5T48C	32	2.5	5	TQFP	48	32	C
	LC4032B-75T48C	32	2.5	7.5	TQFP	48	32	C
	LC4032B-25T44C	32	2.5	2.5	TQFP	44	30	C
	LC4032B-5T44C	32	2.5	5	TQFP	44	30	C
	LC4032B-75T44C	32	2.5	7.5	TQFP	44	30	C
LC4064B	LC4064B-25T100C	64	2.5	2.5	TQFP	100	64	C
	LC4064B-5T100C	64	2.5	5	TQFP	100	64	C
	LC4064B-75T100C	64	2.5	7.5	TQFP	100	64	C
	LC4064B-25T48C	64	2.5	2.5	TQFP	48	32	C
	LC4064B-5T48C	64	2.5	5	TQFP	48	32	C
	LC4064B-75T48C	64	2.5	7.5	TQFP	48	32	C
	LC4064B-25T44C	64	2.5	2.5	TQFP	44	30	C
	LC4064B-5T44C	64	2.5	5	TQFP	44	30	C
	LC4064B-75T44C	64	2.5	7.5	TQFP	44	30	C
LC4128B	LC4128B-27T128C	128	2.5	2.7	TQFP	128	92	C
	LC4128B-5T128C	128	2.5	5	TQFP	128	92	C
	LC4128B-75T128C	128	2.5	7.5	TQFP	128	92	C
	LC4128B-27T100C	128	2.5	2.7	TQFP	100	64	C
	LC4128B-5T100C	128	2.5	5	TQFP	100	64	C
	LC4128B-75T100C	128	2.5	7.5	TQFP	100	64	C

## ispMACH 4000V (3.3V) Extended Temperature Devices

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032V	LC4032V-75T48E	32	3.3	7.5	TQFP	48	32	E
	LC4032V-75T44E	32	3.3	7.5	TQFP	44	30	E
LC4064V	LC4064V-75T100E	64	3.3	7.5	TQFP	100	64	E
	LC4064V-75T48E	64	3.3	7.5	TQFP	48	32	E
	LC4064V-75T44E	64	3.3	7.5	TQFP	44	30	E
LC4128V	LC4128V-75T144E	128	3.3	7.5	TQFP	144	96	E
	LC4128V-75T128E	128	3.3	7.5	TQFP	128	92	E
	LC4128V-75T100E	128	3.3	7.5	TQFP	100	64	E
LC4256V	LC4256V-75T176E	256	3.3	7.5	TQFP	176	128	E
	LC4256V-75T144E	256	3.3	7.5	TQFP	144	96	E
	LC4256V-75T100E	256	3.3	7.5	TQFP	100	64	E

## ispMACH 4000B (2.5V) Lead-Free Commercial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4384B	LC4384B-35FTN256C	384	2.5	3.5	Lead-Free ftBGA	256	192	C
	LC4384B-5FTN256C	384	2.5	5	Lead-Free ftBGA	256	192	C
	LC4384B-75FTN256C	384	2.5	7.5	Lead-Free ftBGA	256	192	C
	LC4384B-35FN256C <sup>1</sup>	384	2.5	3.5	Lead-Free fpBGA	256	192	C
	LC4384B-5FN256C <sup>1</sup>	384	2.5	5	Lead-Free fpBGA	256	192	C
	LC4384B-75FN256C <sup>1</sup>	384	2.5	7.5	Lead-Free fpBGA	256	192	C
	LC4384B-35TN176C	384	2.5	3.5	Lead-Free TQFP	176	128	C
	LC4384B-5TN176C	384	2.5	5	Lead-Free TQFP	176	128	C
LC4512B	LC4512B-35FTN256C	512	2.5	3.5	Lead-Free ftBGA	256	208	C
	LC4512B-5FTN256C	512	2.5	5	Lead-Free ftBGA	256	208	C
	LC4512B-75FTN256C	512	2.5	7.5	Lead-Free ftBGA	256	208	C
	LC4512B-35FN256C <sup>1</sup>	512	2.5	3.5	Lead-Free fpBGA	256	208	C
	LC4512B-5FN256C <sup>1</sup>	512	2.5	5	Lead-Free fpBGA	256	208	C
	LC4512B-75FN256C <sup>1</sup>	512	2.5	7.5	Lead-Free fpBGA	256	208	C
	LC4512B-35TN176C	512	2.5	3.5	Lead-Free TQFP	176	128	C
	LC4512B-5TN176C	512	2.5	5	Lead-Free TQFP	176	128	C
	LC4512B-75TN176C	512	2.5	7.5	Lead-Free TQFP	176	128	C

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

## ispMACH 4000B (2.5V) Lead-Free Industrial Devices

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032B	LC4032B-5TN48I	32	2.5	5	Lead-Free TQFP	48	32	I
	LC4032B-75TN48I	32	2.5	7.5	Lead-Free TQFP	48	32	I
	LC4032B-10TN48I	32	2.5	10	Lead-Free TQFP	48	32	I
	LC4032B-5TN44I	32	2.5	5	Lead-Free TQFP	44	30	I
	LC4032B-75TN44I	32	2.5	7.5	Lead-Free TQFP	44	30	I
	LC4032B-10TN44I	32	2.5	10	Lead-Free TQFP	44	30	I
LC4064B	LC4064B-5TN100I	64	2.5	5	Lead-Free TQFP	100	64	I
	LC4064B-75TN100I	64	2.5	7.5	Lead-Free TQFP	100	64	I
	LC4064B-10TN100I	64	2.5	10	Lead-Free TQFP	100	64	I
	LC4064B-5TN48I	64	2.5	5	Lead-Free TQFP	48	32	I
	LC4064B-75TN48I	64	2.5	7.5	Lead-Free TQFP	48	32	I
	LC4064B-10TN48I	64	2.5	10	Lead-Free TQFP	48	32	I
	LC4064B-5TN44I	64	2.5	5	Lead-Free TQFP	44	30	I
	LC4064B-75TN44I	64	2.5	7.5	Lead-Free TQFP	44	30	I
	LC4064B-10TN44I	64	2.5	10	Lead-Free TQFP	44	30	I